

In the Claims:

1. (Currently Amended) A device for climate control of a vehicle interior, comprising:

a coolant circuit in which coolant flows therethrough;

a compressor positioned in the coolant circuit;

a condenser positioned in the coolant circuit;

an evaporator positioned in the coolant circuit;

a heat source having a cooling circuit;

a liquid heat transfer medium circuit in which a liquid heat transfer medium flows therethrough, said liquid heat transfer medium circuit having connections for receiving liquid heat transfer medium from the cooling circuit of the heat source and for returning liquid heat transfer medium back to the coolant circuit of the heat source;

~~a heat source positioned in the liquid heat transfer medium circuit;~~

[[a]] first and second heat exchangers positioned in the liquid heat transfer medium circuit;

a heat/cold reservoir in which the evaporator and the first heat exchanger are located;
and

a heating/cooling surface for at least one of a driver's bed and vehicle interior wall, said heating/cooling surface being integrated into the liquid heat transfer medium circuit such that a fluid flow connection exists between the heat exchanger and the heating/cooling surface which conveys the liquid at least one of a heat transfer medium flowing through the heat exchanger to and can flow selectively through the heating/cooling surface and a heat transfer medium being conveyed by the heat source can flow through the heating/cooling surface

wherein at least one flow controller which is adapted to selectively open and close said fluid flow connection and at least one flow controller in each of said coolant and liquid heat transfer medium circuits, and

wherein said flow controllers are selectively operable to produce, individually or in selected combinations direct heating of both the heating/cooling surface and also the second heat exchanger with hot heat transfer medium received from the cooling circuit of the heat

source, direct heating of only the second heat exchanger with hot heat transfer medium received from the cooling circuit of the heat source, charging of the heat/cold reservoir with thermal energy from the cooling circuit of the heat source, heating/cooling of the heating/cooling surface with thermal energy from the hot/cold reservoir, heating/cooling of the second heat exchanger with thermal energy from the hot/cold reservoir, charging of the thermal reservoir with thermal energy from the liquid heat transfer medium circuit, and charging of the thermal reservoir with thermal energy from the coolant circuit.

2. (Withdrawn) The device of claim 1, wherein the heating/cooling surface is arranged in a parallel connection to the heat exchanger in the heat transfer medium circuit.

3. (Currently Amended) The device of claim 1, further including a valve positioned to permit remote control of the flow of the liquid heat transfer medium through the heating/cooling surface.

4. (Original) The device of claim 1, further including a second heating/cooling surface for at least one of a second driver's bed and a second vehicle interior wall, said second heating/cooling surface being located in a parallel connection to the first heating/cooling surface.

5. (Original) The device of claim 4, further including a first valve positioned to permit remote control of said first heating/cooling surface and a second valve positioned to permit remote control of said second heating/cooling surface.

6. (Withdrawn) The device of claim 4, further including a common valve is positioned to permit remote control of the flow of heat transfer medium to the parallel connection and thus to the first and second heating/cooling surfaces.

7. (Withdrawn; Currently Amended) The device of claim 4, ~~further including a~~ wherein the second heat exchanger is adapted to receive an air flow therethrough integrated into the heat transfer medium circuit and through which air flows.

8. (Withdrawn) The device of claim 7, wherein at least one of the first and second heating/cooling surfaces is series connected to the second heat exchanger, further including a bypass line positioned to bypass flow around said first and second heating/cooling surfaces and formed with an adjustable flow cross section.

9. (Withdrawn) The device of claim 7, wherein at least one of the first and the second heating/ cooling surfaces is located in a parallel connection to the second heat exchanger.

10. (Currently Amended) The device of claim 1, further including a circulation pump integrated into the liquid heat transfer medium circuit to convey the liquid heat transfer medium through the heat exchanger and the heating/cooling surface.

11. (Currently Amended) The device of claim 10, ~~further including a second heat exchanger integrated into the heat transfer medium circuit,~~ wherein the circulation pump conveys the liquid heat transfer medium through the second heat exchanger.

12. (Original) The device of claims 1, further including a second evaporator integrated into the coolant circuit and through which air flows.